



Smart Additive Manufacturing, Design and Evaluation

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Message from the Guest Editor

Additive manufacturing and 3D printing technologies are globally recognized as novel fabrication processes for advanced materials and components with multifunctional structures. These technologies offer tremendous potential for design innovations and customization, complex part fabrication, rapid prototyping, and distributed digital manufacturing.

In this approach, three-dimensional models are designed and created according to theoretical concepts using computer software, and two-dimensional cross-sections are created by slicing operations automatically. Computer-aided design, manufacture, and evaluation are referred to as smart additive processing.

By using **Smart Additive Manufacturing, Design, and Evaluation**, practical metal and ceramic components with functionally geometric structures are developed to modulate effectively energy dispersions and mass transfers through computer-aided theoretical design, automatic manufacture and visualized evaluation. Smart processes that will help to realize a sustainable society will be discussed in this Special Issue.





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Message from the Editor-in-Chief

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